

## **Low Capacitance TVS Diode**

 ESD / transient protection of high-speed data lines in 3.3 / 5 / 12 V applications according to:

IEC61000-4-2 (ESD): up to  $\pm$  25 KV (contact)

IEC61000-4-4 (EFT): 40 A (5/50 ns)

IEC61000-4-5 (surge): up to 2.5 A (8/20 μs)

- Smallest form factor down to 1.0 x 0.6 x 0.4 mm
- Max. working voltage: -8 / +14 V or +8 / -14 V
- Very low capacitance down to 2 pF
- Very low reverse current < 1 nA typ.
- Very low series inductance down to 0.4 nH
- Pb-free (RoHS compliant) package
- Qualified according AEC Q101

## **Applications**

- USB 2.0, 10/100 Ethernet, Firewire, DVI
- Mobile communication
- Consumer products (STB, MP3, DVD, DSC...)
- LCD displays, camera
- Notebooks and destop computers, peripherals





#### ESD8V0L1B-02LRH

# ESD8V0L2B-03L ESD8V0L2B-03LRH





Туре	Package	Configuration	Marking
ESD8V0L1B-02LRH	TSLP-2-17	1 channel, bi-directional	B3
ESD8V0L2B-03L	TSLP-3-1	2 channels, bi-directional	B3
ESD8V0L2B-03LRH*	TSLP-3-7	2 channels, bi-directional	on request

<sup>\*</sup> Preliminary data





**Maximum Ratings** at  $T_A = 25$ °C, unless otherwise specified

Parameter	Symbol	Value	Unit
ESD contact discharge <sup>1)</sup>	V <sub>ESD</sub>		kV
ESD8V0L1B-02LRH		25	
ESD8V0L2B, between all pins		15	
Peak pulse current ( $t_p = 8 / 20 \mu s)^2$ )	I <sub>pp</sub>		А
ESD8V0L1B-02LRH		2.5	
ESD8V0L2B		1	
Operating temperature range	Top	-55125	°C
Storage temperature	$T_{\rm stg}$	-65150	

 $<sup>^{1}</sup>V_{\mathrm{ESD}}$  according to IEC61000-4-2

 $<sup>^2</sup>I_{\mbox{\footnotesize pp}}$  according to IEC61000-4-5



**Electrical Characteristics** at  $T_A$  = 25°C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Characteristics					
Reverse working voltage	$V_{RWM}$	-8	-	14	V
Breakdown voltage	$V_{(BR)}$				
$I_{(BR)}$ = 1 mA, from pin 2 to 1, ESD8V0L1B-02LRH		14.5	-	-	
$I_{(BR)}$ = 1 mA, from pin 1 to 2, ESD8V0L1B-02LRH	I	8.5	-	-	
$I_{(BR)} = 1 \text{ mA}$ , from pin 1/2 to 3, ESD8V0L2B		14.5	-	-	
$I_{(BR)}$ = 1 mA, from pin 3 to 1/2, ESD8V0L2B		8.5	-	-	
$I_{(BR)}$ = 1 mA, from pin 1 to 2, ESD8V0L2B		23	-	-	
Reverse current	I <sub>R</sub>	-	< 1	50	nA
$V_{R}$ = 3 V, between all pins					
Clamping voltage for ESD8V0L2B	$V_{CL}$				V
$V_{\text{ESD}}$ = +15 kV (contact) <sup>1)</sup> , from pin 1/2 to 3		-	26	-	
$V_{\text{ESD}}$ = -15 kV (contact) <sup>1)</sup> , from pin 1/2 to 3		-	20	-	
Line capacitance <sup>2)</sup>	C <sub>T</sub>				pF
$V_{R} = 0 \text{ V}, f = 1 \text{ MHz}, ESD8V0L1B-02LRH}$		-	8.5	13	
$V_{R} = 0 \text{ V}, f = 1 \text{ MHz}, ESD8V0L2B,}$					
from pin 1/2 to 3		-	4	7	
from pin 1 to 2, pin 3 is not connected		-	2	4	
Dynamic resistance ( tp=30ns )	$R_{D}$				Ω
ESD8V0L1B-02LRH		-	0.3	-	
ESD8V0L2B		-	0.6	-	

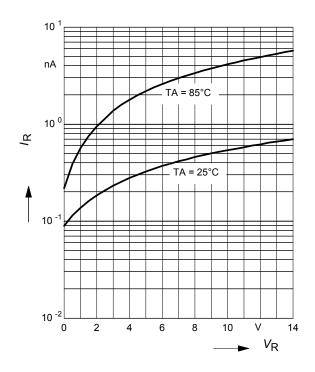
 $<sup>^{1}</sup>V_{\mbox{\footnotesize ESD}}$  according to IEC61000-4-2

<sup>&</sup>lt;sup>2</sup>Total capacitance line to ground



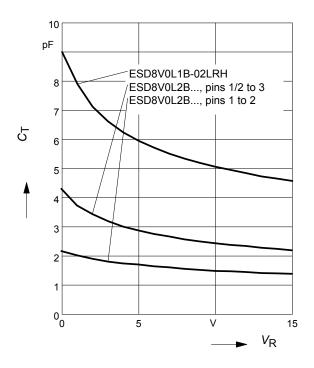
# Reverse current $I_R = f(V_R)$

# $T_A$ = Parameter



# Diode capacitance $C_T = f(V_R)$

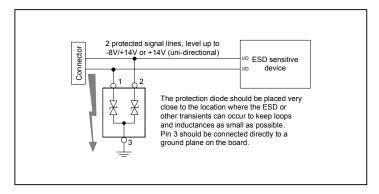
f = 1MHz





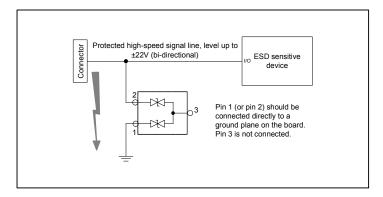
#### Application example ESD8V0L2B...

2 channels, bi-directional



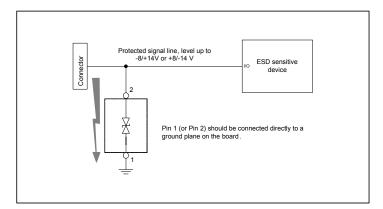
# Application example ESD8V0L2B...

1 high-speed channel, bi-directional



## Application example ESD8V0L1B-02LRH

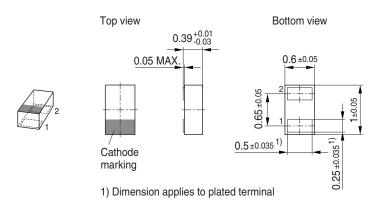
1 channel, bi-directional



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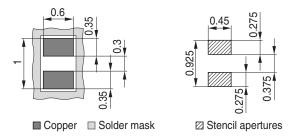


# Package Outline

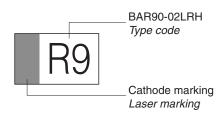


## Foot Print

For board assembly information please refer to Infineon website "Packages"

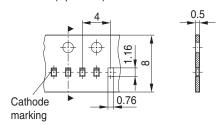


# Marking Layout (Example)



# Standard Packing

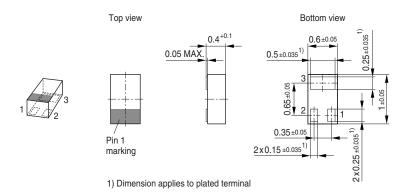
Reel ø180 mm = 15.000 Pieces/Reel Reel ø330 mm = 50.000 Pieces/Reel (optional)



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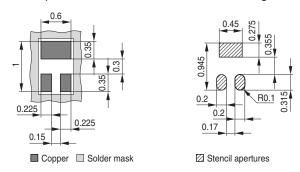


# Package Outline

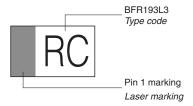


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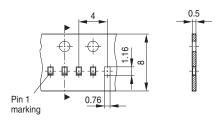


# Marking Layout (Example)



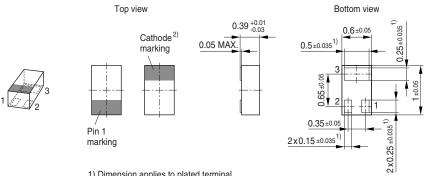
# Standard Packing

Reel ø180 mm = 15.000 Pieces/Reel





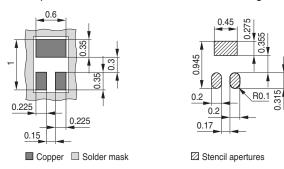
# Package Outline



- 1) Dimension applies to plated terminal
- 2) Only for diodes, cathode marking on pin 3

## Foot Print

For board assembly information please refer to Infineon website "Packages"

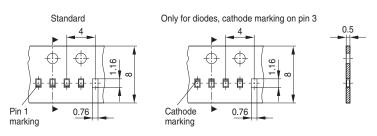


## Marking Layout



# Standard Packing

Reel ø180 mm = 15.000 Pieces/Reel



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